

Changes to the MELSEC iQ-F series spring clamp terminal block parts

■Date of Issue

July 2019

■Relevant Models

FX5UC-32MR/DS-TS, FX5UC-32MT/DS-TS, FX5UC-32MT/DSS-TS, FX5-C32EX/DS-TS, FX5-C16EYR/D-TS, FX5-C32EYT/D-TS, FX5-C32EYT/DSS-TS, FX5-C32ET/DS-TS, FX5-C32ET/DSS-TS, FX5-4AD, FX5-4DA, FX5-8AD, FX5-4LC

Thank you for your continued support of programmable controllers MELSEC iQ-F series.

We would like to announce the changes of the spring clamp terminal block parts.

There is no impact on the specifications (general specifications, performance specifications, etc.), functions, and external dimensions of modules due to this change.

1 Applicable models

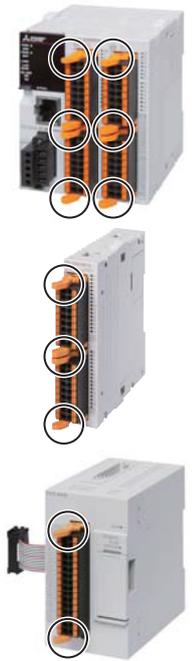
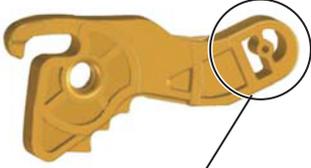
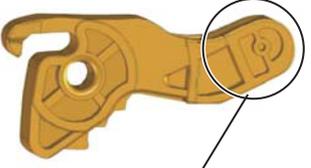
Product	Model
CPU module	FX5UC-32MR/DS-TS, FX5UC-32MT/DS-TS, FX5UC-32MT/DSS-TS
Input module	FX5-C32EX/DS-TS
Output module	FX5-C16EYR/D-TS, FX5-C32EYT/D-TS, FX5-C32EYT/DSS-TS
Input/output module	FX5-C32ET/DS-TS, FX5-C32ET/DSS-TS
Analog input module	FX5-4AD
Analog output module	FX5-4DA
Multiple input module	FX5-8AD
Temperature control module	FX5-4LC

2 Reason for the change

To improve productivity, the shape of the lever of the spring clamp terminal block will be changed.

3 Content of the change

The shape of the lever of the spring clamp terminal block is changed as below.

Changed Items	Changed Positions	Before change	After change
Shape of the lever of the spring clamp terminal block		 <p>A part of the resin is penetrated.</p>	 <p>A part of the resin is not penetrated.</p>

4 Changeover period

The changes will be applied to the products manufactured in September 2019 and later.

Depending on stock status, both the old and new products may be distributed in the market around that time.

REVISIONS

Version	Date of Issue	Revision
A	July 2019	First edition

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